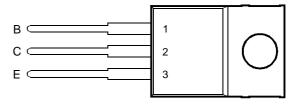
- Designed for Complementary Use with TIP110, TIP111 and TIP112
- 50 W at 25°C Case Temperature
- 4 A Continuous Collector Current
- Minimum h<sub>FE</sub> of 500 at 4 V, 2 A

# TO-220 PACKAGE (TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRACA

# absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING			VALUE	UNIT
	TIP115		-60	
Collector-base voltage (I <sub>E</sub> = 0)	TIP116	$V_{CBO}$	-80	V
	TIP117		-100	
	TIP115		-60	
Collector-emitter voltage (I <sub>B</sub> = 0)	TIP116	$V_{CEO}$	-80	V
	TIP117		-100	
Emitter-base voltage			-5	V
Continuous collector current			-4	Α
Peak collector current (see Note 1)			-6	Α
Continuous base current			-50	mA
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)			50	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)			2	W
Unclamped inductive load energy (see Note 4)			25	mJ
Operating junction temperature range			-65 to +150	°C
Storage temperature range			-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds			260	°C

NOTES: 1. This value applies for  $t_p \leq 0.3$  ms, duty cycle  $\leq 10\%.$ 

- 2. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.
- 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
- 4. This rating is based on the capability of the transistor to operate safely in a circuit of: L = 20 mH,  $I_{B(on)}$  = -5 mA,  $R_{BE}$  = 100  $\Omega$ ,  $V_{BE(off)}$  = 0,  $R_S$  = 0.1  $\Omega$ ,  $V_{CC}$  = -20 V.



# TIP115, TIP116, TIP117 PNP SILICON POWER DARLINGTONS

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# electrical characteristics at 25°C case temperature

	PARAMETER		TEST CONDIT	TIONS	MIN	TYP	MAX	UNIT
V <sub>(BR)CEO</sub> Collector-emitter breakdown volta	Collector-emitter			TIP115	-60			
		$I_C = -30 \text{ mA}$	$I_B = 0$	TIP116	-80			V
	Dioanaowii vonago	(see Note 5)		TIP117	-100			
Collector-emitter I <sub>CEO</sub> cut-off current	Collector emitter	V <sub>CE</sub> = -30 V	I <sub>B</sub> = 0	TIP115			-2	
	$V_{CE} = -40 \text{ V}$	$I_B = 0$	TIP116			-2	mA	
	cut-on current	$V_{CE} = -50 \text{ V}$	$I_B = 0$	TIP117			-2	
Collector cut-off current	Collector out off	V <sub>CB</sub> = -60 V	I <sub>E</sub> = 0	TIP115			-1	
	$V_{CB} = -80 \text{ V}$	$I_E = 0$	TIP116			-1	mA	
	current	V <sub>CB</sub> = -100 V	$I_E = 0$	TIP117			-1	
I <sub>EBO</sub>	Emitter cut-off	V <sub>EB</sub> = -5 V	/ <sub>FB</sub> = -5 V				-2	mA
'EBO	current	AEB - OA	10 = 0				_	1117 \
h <sub>FE</sub>	Forward current	V <sub>CE</sub> = -4 V	I <sub>C</sub> = -1 A	(see Notes 5 and 6)	1000			
''FE	transfer ratio	$V_{CE} = -4 V$	$I_C = -2 A$	(See Notes 5 and 6)	500			
V	Collector-emitter	I <sub>B</sub> = -8 mA	I <sub>C</sub> = -2 A	(see Notes 5 and 6)			-2.5	V
V <sub>CE(sat)</sub>	saturation voltage						-2.5	V
V <sub>BE</sub>	Base-emitter	V <sub>CE</sub> = -4 V	I <sub>C</sub> = -2 A	(see Notes 5 and 6)			-2.8	V
	voltage						-2.0	V
V <sub>EC</sub>	Parallel diode	I <sub>E</sub> = -5 A	I <sub>B</sub> = 0	(see Notes 5 and 6)			-3.5	V
	forward voltage	I <sub>E</sub> = -5 A	1B – 0	(See Notes 5 and 6)			-5.5	v

NOTES: 5. These parameters must be measured using pulse techniques,  $t_p$  = 300  $\mu$ s, duty cycle  $\leq$  2%.

# resistive-load-switching characteristics at 25°C case temperature

	PARAMETER	TEST CONDITIONS †		MIN	TYP	MAX	UNIT	
t <sub>on</sub>	Turn-on time	I <sub>C</sub> = -2 A	$I_{B(on)} = -8 \text{ mA}$	$I_{B(off)} = 8 \text{ mA}$		2.6		μs
t <sub>off</sub>	Turn-off time	$V_{BE(off)} = 5 V$	$R_L = 15 \Omega$	$t_p = 20 \ \mu s, \ dc \le 2\%$		4.5		μs

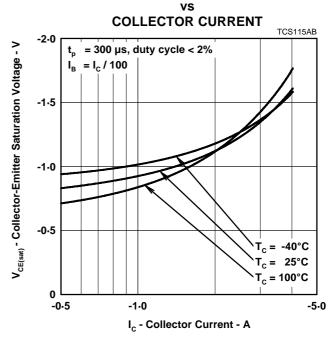
<sup>&</sup>lt;sup>†</sup> Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

<sup>6.</sup> These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

#### TYPICAL CHARACTERISTICS

# **TYPICAL DC CURRENT GAIN COLLECTOR CURRENT** TCS115AA 20000 $T_c = -40$ °C 25°C 10000 $T_c = 100$ °C h<sub>FE</sub> - Typical DC Current Gain 1000 = 300 µs, duty cycle < 2% 100 -0-5 -1-0 -5-0 I<sub>C</sub> - Collector Current - A

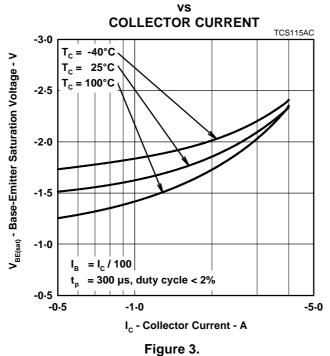
### **COLLECTOR-EMITTER SATURATION VOLTAGE**



#### Figure 1.

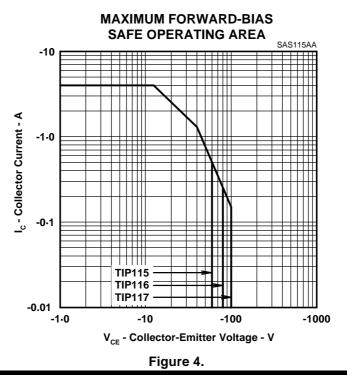
Figure 2.

# **BASE-EMITTER SATURATION VOLTAGE**



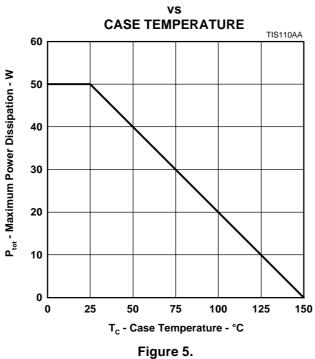


#### **MAXIMUM SAFE OPERATING REGIONS**



#### THERMAL INFORMATION

#### **MAXIMUM POWER DISSIPATION**



# PRODUCT INFORMATION

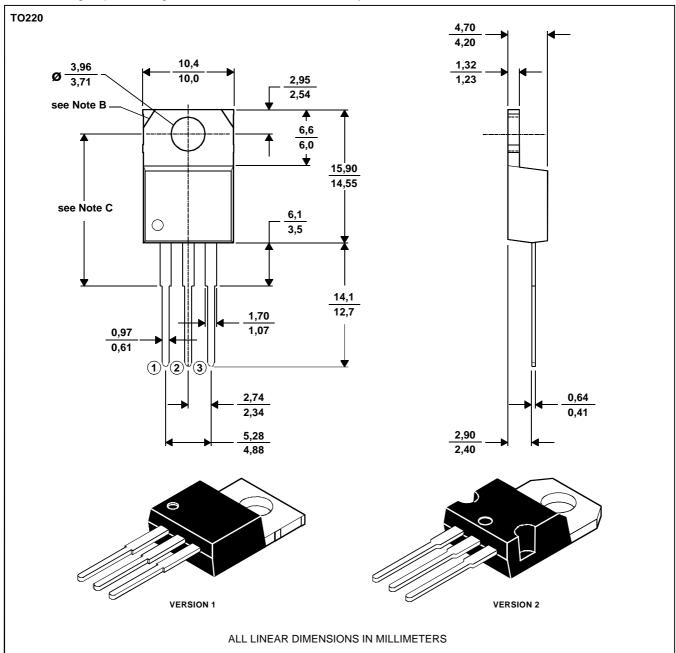
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#### **MECHANICAL DATA**

#### **TO-220**

## 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm. Version 2, 17.6 mm. **MDXXBE** 

#### PRODUCT INFORMATION

# TIP115, TIP116, TIP117 PNP SILICON POWER DARLINGTONS

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